

Practitioner's Docket No.: APA-0217

PATENT APPLICATION**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:

AUG 10 2005

Kazuya MAEKAWA, et al

Application No.: 10/509,895

Confirmation No.: 2978

Filed: October 01, 2004

Art Unit: 3724

For: MEHOD FOR SEVERING BRITTLE
MATERIAL SUBSTRATE AND SEVERING
APPARATUS USING THE METHOD

Examiner: Not Yet Assigned

**Attention: Office of Initial Patent Examination's
Customer Service Center**

Commissioner for Patents**P.O. Box 1450****Alexandria, VA 22313-1450****REQUEST FOR CORRECTED FILING RECEIPT**

- Attached is a copy of the official filing receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested. Also enclosed is a copy of the Japanese language Declaration.
- There is an error with respect to the following, which is incorrectly entered.

Error in

1. Title

Correct data

1. Method for severing brittle material substrate and severing apparatus using the method

3. The correction is due to an error by the USPTO. If any fee is due, please charge Deposit Account No. 18-0013.

Dated: August 10, 2005



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